

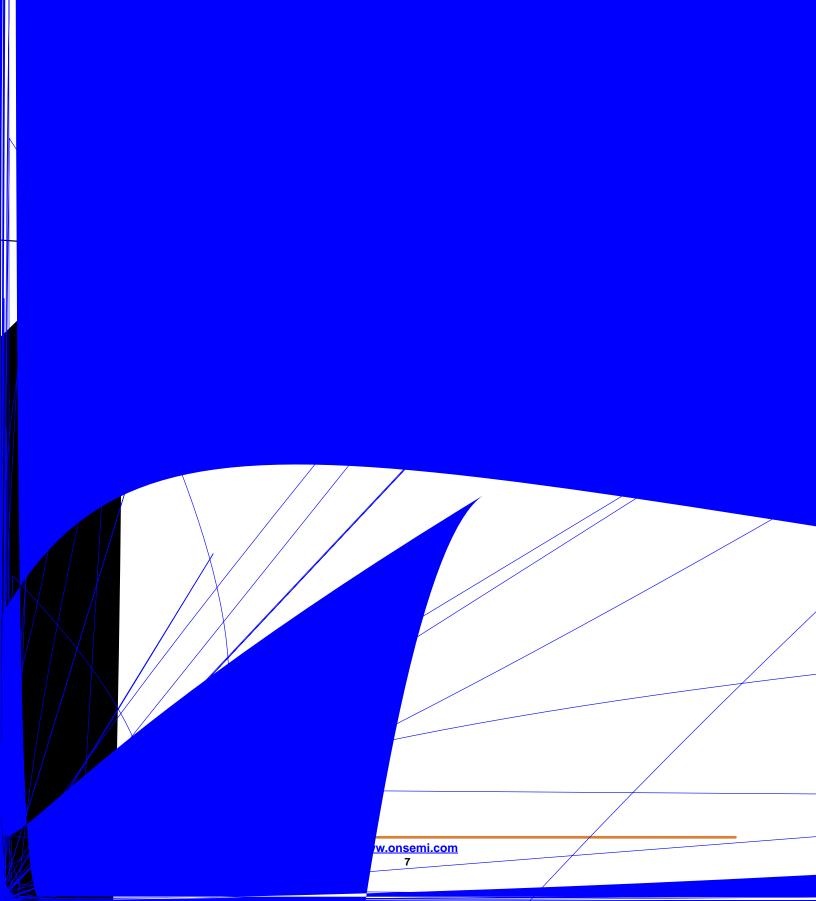
THERMAL CHARACTERISTICS

Parameter	Symbol	Тур	Max	Units
Thermal Resistance Junction-to-Case (Note 2)	R _{JC}	1.08	-	C/W
Thermal Resistance Junction-to-Ambient (Notes 1, 2)	R _{JA}	-	-	

ELECTRICAL CHARACTERISTICS (T_J = 25 C unless otherwise stated)

Parameter	Symbol	Test Condition	Min	Тур	Max	Unit				
SOURCE-DRAIN DIODE CHARACTERISTICS										
Reverse Recovery Time	t _{RR}	V _{GS} = -5/18 V, I _{SD} = 15 A, dI _S /dt = 1000 A/μs (Note 5)		16		ns				
Reverse Recovery Charge	Q _{RR}			66		nC				
Reverse Recovery Energy	E _{REC}			2.6		μJ				
Peak Reverse Recovery Current	I _{RRM}			8.4		А				
Charge time	Та			8.6		ns				
Discharge time	Tb	1		7.1		ns				

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 5. Defind by design, not subject to production test.



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